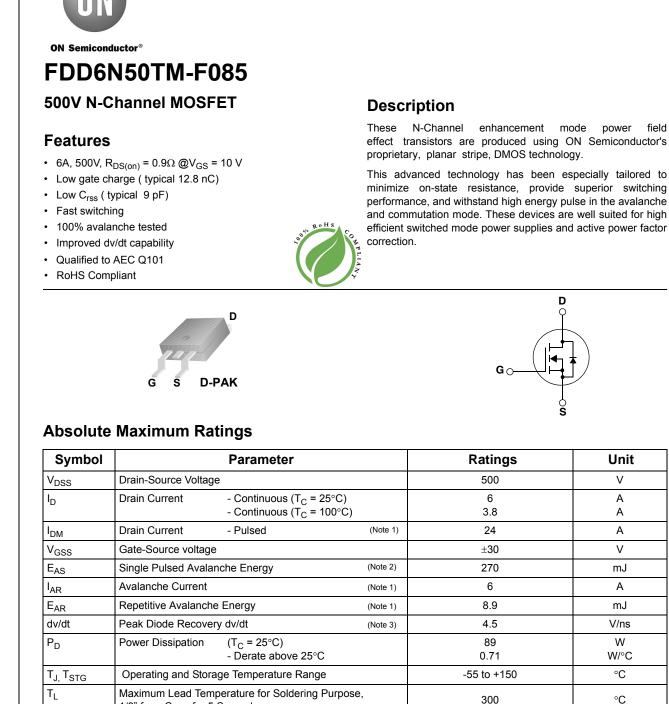
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Thermal Characteristics

1/8" from Case for 5 Seconds

Symbol	Parameter	Min.	Max.	Unit
R_{\thetaJC}	Thermal Resistance, Junction-to-Case		1.4	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient		83	°C/W

FDD6N50TM-F085
500V
N-Channel
annel MOSFET

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6N50	FDD6N50TM-F085	D-PAK	380mm	16mm	2500

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
Off Charac	teristics			1	1	I
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	500			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V			-100	nA
On Charac	teristics					•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 3A		0.76	0.9	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40V, I_D = 3A$ (Note 4)		2.5		S
Dynamic C	haracteristics					•
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V,		720	940	pF
C _{oss}	Output Capacitance	f = 1.0MHz		95	190	pF
C _{rss}	Reverse Transfer Capacitance			9	13.5	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250V, I _D = 6A		6	20	ns
t _r	Turn-On Rise Time	$R_{G} = 25\Omega$		55	120	ns
t _{d(off)}	Turn-Off Delay Time			25	60	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		35	80	ns
Qg	Total Gate Charge	V _{DS} = 400V, I _D = 6A		12.8	16.6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		3.7		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		5.8		nC
Drain-Sour	ce Diode Characteristics and Maximur	n Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				6	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				24	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 6A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 6A		275		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$ (Note 4)		1.7		μC

NOTES:

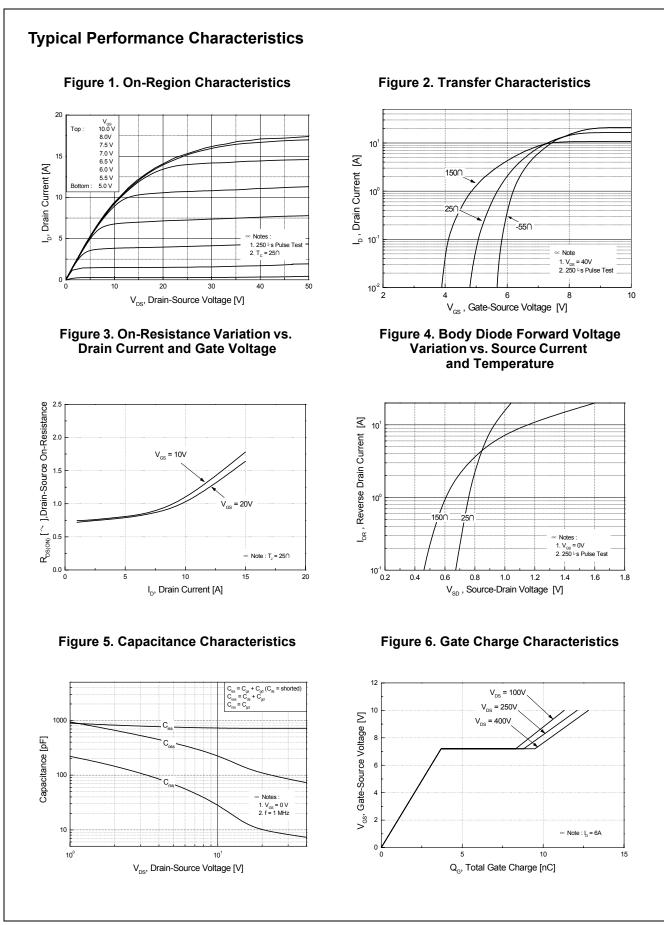
1. Repetitive Rating: Pulse width limited by maximum junction temperature

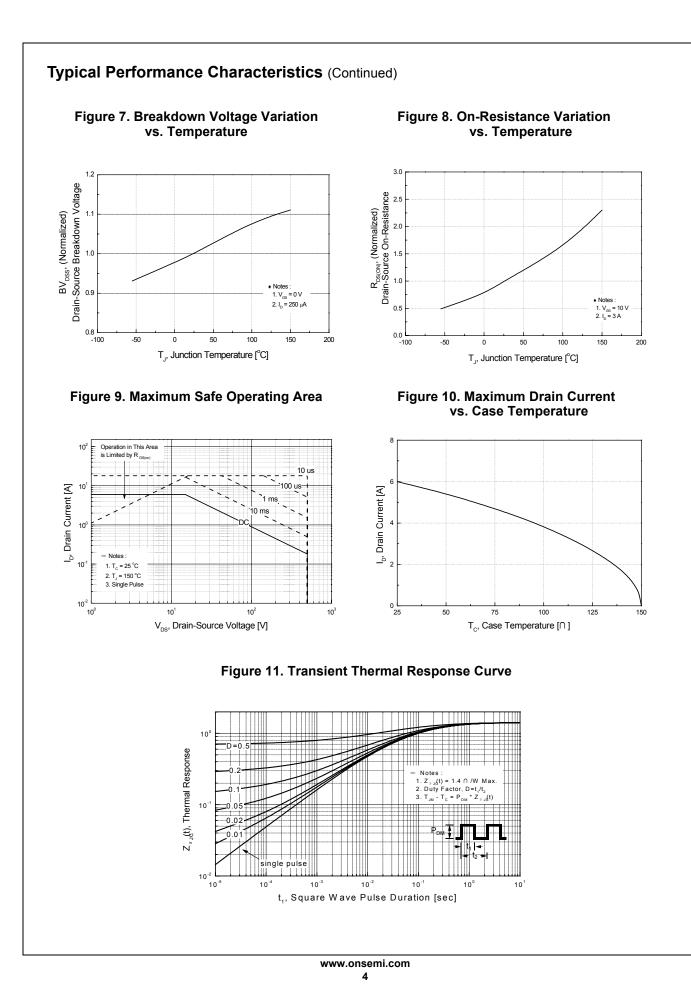
2. I_{AS} = 6A, V_{DD} = 50V, L=13.5mH, R_{G} = 25 Ω , Starting T_{J} = 25°C

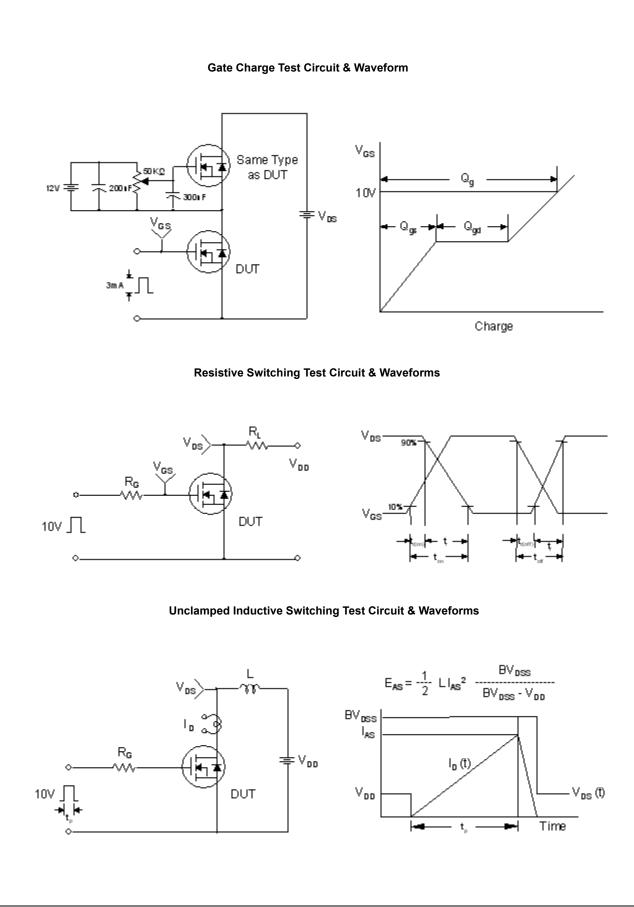
3. I_{SD} \leq 6A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

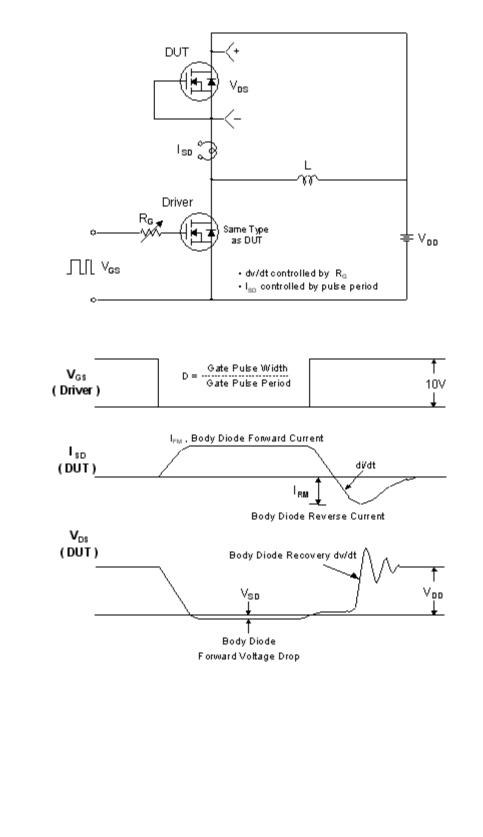


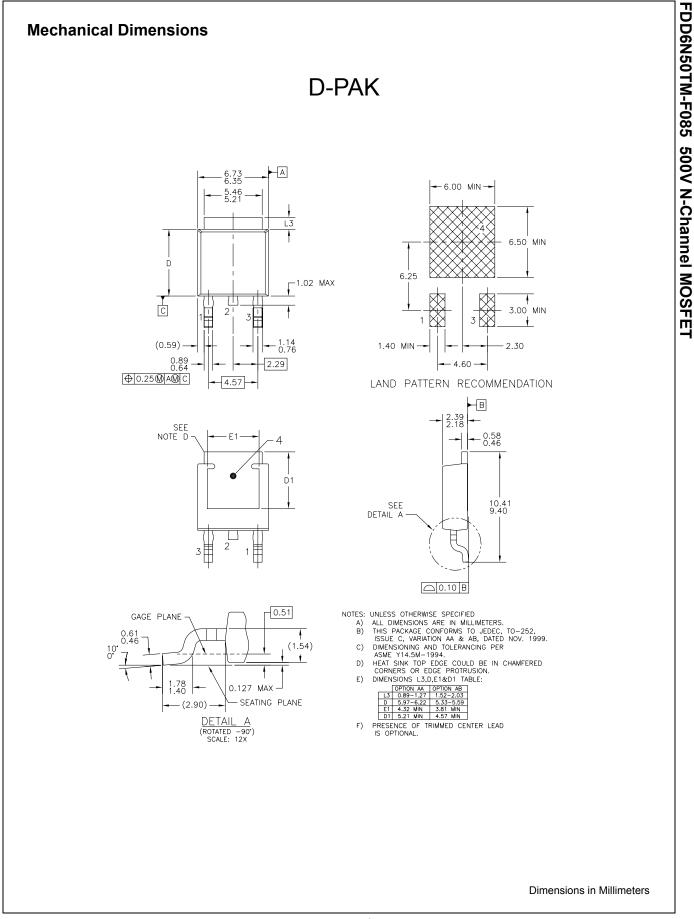




FDD6N50TM-F085 500V N-Channel MOSFET

Peak Diode Recovery dv/dt Test Circuit & Waveforms





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